| FA   | IRCHI  | LD   |   |  |  | March 1999  |  |
|--|--|--|---|--|--|---|--|
|  |  |  |   |  |  |   |  |
|  | 6324L<br>arated Lo   | ad Switch  |   |  |  |   |  |
| -  | -  |  |   | Features   |  |   |  |
|  | I Description  |  |   |  |  |   |  |
| These Integrated Load Switches are produced using Fairchild's proprietary, high cell density, DMOS technology. This very high density process is especially tailored to minimize on-state resistance and provide superior switching performance. These devices are particularly suited for low voltage high side load switch application where low conduction loss and ease of driving |  |  | ology. This very high<br>o minimize on-state<br>performance. These<br>Itage high side load  | <ul> <li>V<sub>DROP</sub>=0.2V @ V<sub>IN</sub>=12V, I<sub>L</sub>=1A, V<sub>ONOFF</sub>=1.5 to 8V<br/>V<sub>DROP</sub>=0.3V @ V<sub>IN</sub>=5V, I<sub>L</sub>=1A, V<sub>ONOFF</sub>=1.5 to 8V.</li> <li>High density cell design for extremely low on-resistance.</li> <li>V<sub>ONOFF</sub> Zener protection for ESD ruggedness. &gt;6KV Human Body Model.</li> </ul> |  |   |  |
| are need   | ed.  |  |   | ■ SuperSOT <sup>TM</sup> -6  | i package design using co<br>ectrical capabilities.                        | pper lead frame for super   |  |
| I  | ÷  |  |   |  |  |   |  |
| SOT-   | -23  | SuperSOT <sup>™</sup> -6   | SuperSOT <sup>™</sup> -8  | SO-8   | SOT-223  | SOIC-16   |  |
|  |  | RE   | ON/OFF 5<br>  |  | Vout,C1 IN •<br>ON/OFF   | Votor<br>Votor<br>OUT   |  |
| Supe   | <sub>pin</sub> 1 <sup>1</sup><br>erSOT ™_6   |  | R1,C1 6   |  | Vout,C1  |   |  |
| \bsolu   | erSOT ™6<br><u>ute Operatii</u>  |  | R1,C1 6   |  | Vout,C1  | · · · · · · · · · · · · · · · · · · ·   |  |
| L <b>bsolu</b><br>ymbol  | erSOT <sup>™</sup> 6<br>ute Operatii<br>Parameter  | ng Range ा₄  | R1,C1 6   |  | Vout,C1  |   |  |
| \bsolu<br>ymbol  | erSOT ™6<br>ute Operatiu<br>Parameter<br>Input Voltage   | n <b>g Range</b> T <sub>A</sub> .<br>Range   | R1,C1 6   |  | Vout,C1<br>ON/OFF<br>R2<br>FDC6324L  |   |  |
| Absolu<br>ymbol<br>IN<br>ON/OFF  | erSOT ™6<br>ute Operatii<br>Parameter<br>Input Voltage<br>ON/OFF Volta   | n <b>g Range</b> T <sub>A</sub> :<br>Range<br>Ige Range  | R1,C1 6 See A   |  | Vout,C1<br>N/OFF<br>R2<br>FDC6324L<br>3 - 20                               |   |  |
| Absolu<br>ymbol<br>IN<br>ON/OFF  | erSOT ™6<br>ute Operatii<br>Parameter<br>Input Voltage<br>ON/OFF Volta   | n <b>g Range</b> T <sub>A</sub> .<br>Range   | = 25°C unless otherwise noted   | pplication Circuit   | Vout,C1<br>N/OFF<br>R2<br>FDC6324L<br>3 - 20<br>1.5 - 8                    | Units V V V   |  |
| NDSOLU<br>ymbol<br>IN<br>ON/OFF  | erSOT ™6<br>ute Operatiu<br>Parameter<br>Input Voltage<br>ON/OFF Volta<br>Load Current   | ng Range <sub>T<sub>A</sub></sub> :<br>Range<br>Ige Range<br>@ V <sub>DROP</sub> =0.5V - Co  | = 25°C unless otherwise noted<br>ntinuous (Note 1)<br>- Pulsed (Note 1 & 3  | pplication Circuit   | Vout,C1<br>R2<br><b>FDC6324L</b><br>3 - 20<br>1.5 - 8<br>1.5<br>2.5        | Units   |  |
| Lbsolu<br>ymbol<br>IN<br>ONVOFF  | erSOT ™6<br>ute Operatin<br>Parameter<br>Input Voltage<br>ON/OFF Volta<br>Load Current<br>Maximum Pow  | n <b>g Range</b> T <sub>A</sub> :<br>Range<br>Ige Range  | = 25°C unless otherwise noted<br>ntinuous (Note 1)<br>- Pulsed (Note 1 & 3<br>(Note 2a)   | pplication Circuit   | Vout,C1<br>R2<br><b>FDC6324L</b><br>3 - 20<br>1.5 - 8<br>1.5               | Units V V A   |  |
| bsolu<br>ymbol<br>N<br>ONVOFF  | erSOT ™6<br>ute Operation<br>Parameter<br>Input Voltage<br>ON/OFF Volta<br>Load Current<br>Maximum Pow<br>Operating and  | ng Range<br>Range<br>Ige Range<br>@ V <sub>DROP</sub> =0.5V - Co<br>ver Dissipation<br>Storage Temperatu<br>Discharge Rating MII             | = 25°C unless otherwise noted<br>ntinuous (Note 1)<br>- Pulsed (Note 1 & 3<br>(Note 2a)   | pplication Circuit   | Vout,C1<br>R2<br><b>FDC6324L</b><br>3 - 20<br>1.5 - 8<br>1.5<br>2.5<br>0.7 | Units Units V V V V W W   |  |
| Absolu<br>ymbol<br>IN<br>ON/OFF<br>L<br>D<br>J, T <sub>STG</sub><br>SD   | erSOT ™6<br>ute Operatin<br>Parameter<br>Input Voltage<br>ON/OFF Volta<br>Load Current<br>Maximum Pow<br>Operating and<br>Electrostatic D  | ng Range<br>Range<br>Ige Range<br>@ V <sub>DROP</sub> =0.5V - Co<br>ver Dissipation<br>Storage Temperatu<br>Discharge Rating MII<br>15000hm) | = 25°C unless otherwise noted<br>ntinuous (Note 1)<br>- Pulsed (Note 1 & 3<br>(Note 2a)<br>re Range   | pplication Circuit   | Vout,C1<br>R2  | Image: Constraint of the second sec |  |
| Absolu<br>symbol<br>in<br>onvoff<br>L<br>J<br>J, T <sub>STG</sub><br>SD  | erSOT <sup>™</sup> 6<br>ute Operatin<br>Parameter<br>Input Voltage<br>ON/OFF Volta<br>Load Current<br>Maximum Pow<br>Operating and<br>Electrostatic D<br>Model (100pf//<br>L CHARACTER | ng Range<br>Range<br>Ige Range<br>@ V <sub>DROP</sub> =0.5V - Co<br>ver Dissipation<br>Storage Temperatu<br>Discharge Rating MII<br>15000hm) | = 25°C unless otherwise noted<br>= 25°C unless otherwise noted<br>ntinuous (Note 1)<br>- Pulsed (Note 1 & 3<br>(Note 2a)<br>re Range<br>L-STD-883D Human Body | pplication Circuit   | Vout,C1<br>R2  | Image: Constraint of the second sec |  |

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| Symbol              | Parameter                    | Conditions   | Min | Тур   | Max | Units |
|---------------------|------------------------------|--|-----|-------|-----|-------|
| OFF CHAR            | ACTERISTICS                  |  | •   |       |     | -     |
| I <sub>FL</sub>     | Forward Leakage Current      | V <sub>IN</sub> = 20 V, V <sub>ON/OFF</sub> = 0 V                              |     |       | 1   | μA    |
| I <sub>RL</sub>     | Reverse Leakage Current      | V <sub>IN</sub> = -20 V, V <sub>ON/OFF</sub> = 0 V                             |     |       | -1  | μΑ    |
| ON CHAR             | ACTERISTICS (Note 3)         | · ·  |     |       |     |       |
| V <sub>IN</sub>     | Input Voltage                |  | 3   |       | 20  | V     |
| V <sub>ON/OFF</sub> | On/Off Voltage               |  | 1.5 |       | 8   | V     |
| V <sub>DROP</sub>   | Conduction Voltage Drop @ 1A | V <sub>IN</sub> = 10 V, V <sub>ON/OFF</sub> = 3.3V                             |     | 0.135 | 0.2 | V     |
|                     |                              | V <sub>IN</sub> = 5 V, V <sub>ONOFF</sub> = 3.3 V                              |     | 0.215 | 0.3 | 1     |
| IL                  | Load Current                 | V <sub>DROP</sub> = 0.2 V, V <sub>IN</sub> = 10 V, V <sub>ON/OFF</sub> = 3.3 V | 1   |       |     | Α     |
|                     |                              | V <sub>DROP</sub> = 0.3 V, V <sub>IN</sub> = 5 V, V <sub>ON/OFF</sub> = 3.3 V  | 1   |       |     | 1     |

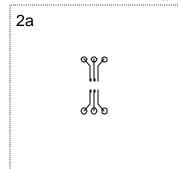
Notes:

1.  $V_{IN}$ =20V,  $V_{ONOFF}$ =8V,  $V_{DROP}$ =0.5V,  $T_A$ =25°C

2. R<sub>BA</sub> is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R<sub>BA</sub> is guaranteed by design while  $\mathrm{R}_{_{\theta CA}}$  is determined by the user's board design.

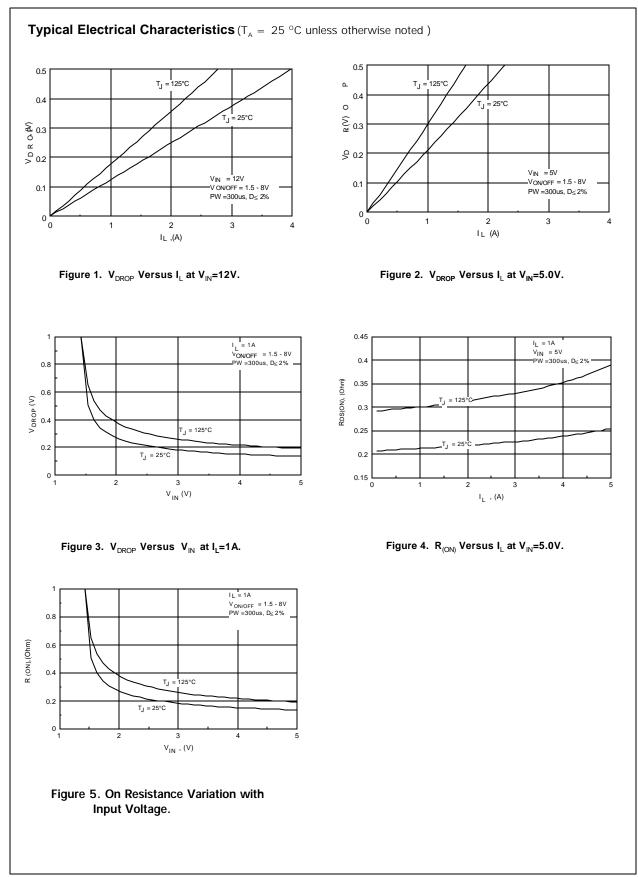
 $P_{D}(t) = \frac{T_{r}T_{s}}{R_{0,j}t} = \frac{T_{r}-T_{s}}{R_{0,j}tR_{0,c}(t)} = I_{D}^{2}(t) \times R_{DQON(\mathcal{G}_{J})}$ Typical R<sub>0.4</sub> for single device operation using the board layouts shown below on FR-4 PCB in astill air environment

a. 180°C/W when mounted on a 2oz minimum copper pad.

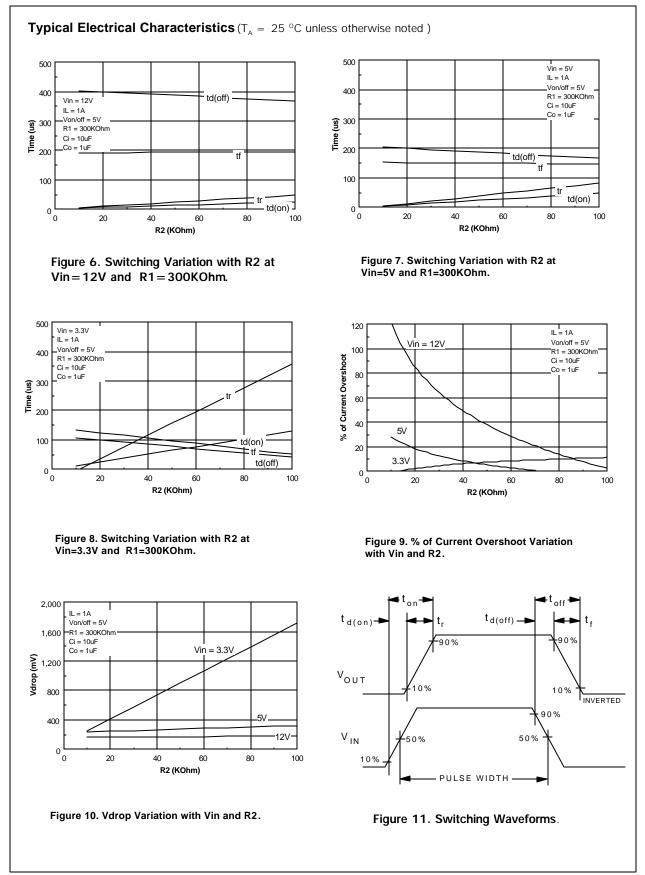


Scale 1 : 1 on letter size paper

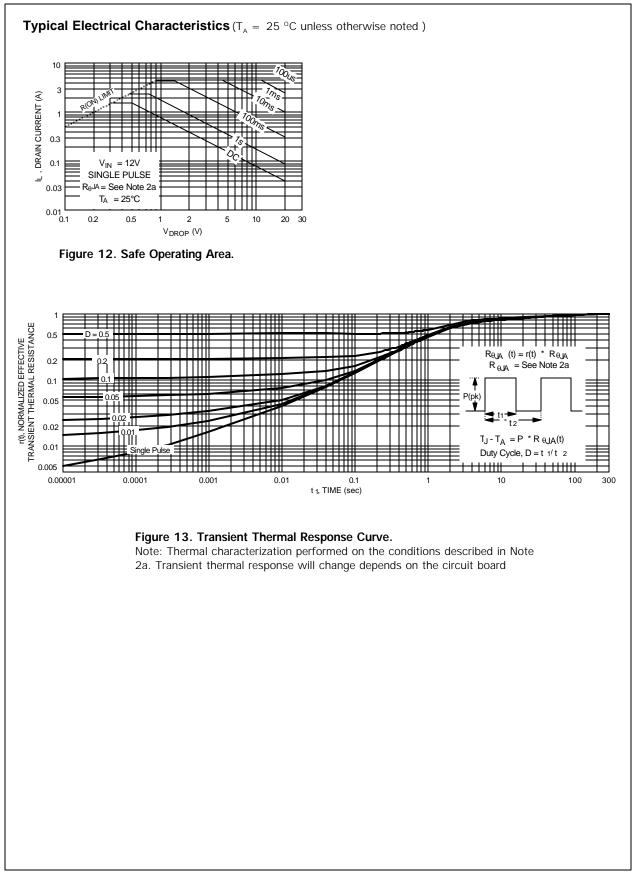
3. Pulse Test: Pulse Width < 300µs, Duty Cycle< 2.0%



FDC6324L Rev.D

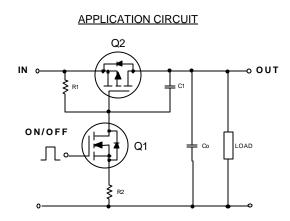


FDC6324L Rev. D



FDC6324L Rev. D

# FDC6324L Load Switch Application



### **General Description**

This device is particularly suited for computer peripheral switching applications where 20V input and 1A output current capability are needed. This load switch integrates a small N-Channel Power MOSFET (Q1) which drives a large P-Channel Power MOSFET (Q2) in one tiny SuperSOT<sup>TM</sup>-6 package.

A load switch is usually configured for high side switching so that the load can be isolated from the active power source. A P-Channel Power MOSFET, because it does not require its drive voltage above the input voltage, is usually more cost effective than using an N-Channel device in this particular application. A large P-Channel Power MOSFET minimizes voltage drop. By using a small N-Channel device the driving stage is simplified.

#### Component Values

| R1 | Typical 10k - $1M\Omega$ |            |
|----|--------------------------|------------|
| R2 | Typical 0-10kΩ           | (optional) |
| C1 | Typical 1000pF           | (optional) |

## Design Notes

- R1 is needed to turn off Q2.
- R2 can be used to soft start the switch in the case the output capacitance Co is small.
- $R2 \leq$  should be at least 10 times smaller than R1 to guarantee Q1 turns on.
- By using R1 and R2 a certain amount of current is lost from the input. This bias current loss is given by the equation

 $I_{BIAS \_LOSS} = \frac{Vin}{R1 \pm R2}$  when the switch is ON.  $I_{BIAS \_LOSS}$  can be minimized by large R1.

• R2 and C<sub>RSS</sub> of Q2 make ramp for slow turn on. If excessive overshoot current occurs due to fast turn on, additional capacitance C1 can be added externally to slow down the turn on.

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TinyLogic™ UHC™ VCX™

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|--------------------------|---------------------------|---|
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